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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	5
Program Memory Size	1.5KB (1K x 12)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	41 × 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12f509t-e-sn

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Device	Program Memory	Data Memory	1/0	Timers	
Device	Flash (words)	SRAM (bytes)	1/0	8-bit	
PIC12F508	512	25	6	1	
PIC12F509	1024	41	6	1	
PIC16F505	1024	72	12	1	

NOTES:

2.0 PIC12F508/509/16F505 DEVICE VARIETIES

A variety of packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in this section. When placing orders, please use the PIC12F508/509/16F505 Product Identification System at the back of this data sheet to specify the correct part number.

2.1 Quick Turn Programming (QTP) Devices

Microchip offers a QTP programming service for factory production orders. This service is made available for users who choose not to program medium-to-high quantity units and whose code patterns have stabilized. The devices are identical to the Flash devices but with all Flash locations and fuse options already programmed by the factory. Certain code and prototype verification procedures do apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

2.2 Serialized Quick Turn ProgrammingSM (SQTPSM) Devices

Microchip offers a unique programming service, where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number, which can serve as an entry code, password or ID number.





Nama	Eurotion	Input	Output	Description
Name	Function	Туре	Туре	Description
GP0/ICSPDAT	GP0	TTL	CMOS	Bidirectional I/O pin. Can be software programmed for internal
				weak pull-up and wake-up from Sleep on pin change.
	ICSPDAT	ST	CMOS	In-Circuit Serial Programming™ data pin.
GP1/ICSPCLK	GP1	TTL	CMOS	Bidirectional I/O pin. Can be software programmed for internal weak pull-up and wake-up from Sleep on pin change.
	ICSPCLK	ST	CMOS	In-Circuit Serial Programming clock pin.
GP2/T0CKI	GP2	TTL	CMOS	Bidirectional I/O pin.
	TOCKI	ST	—	Clock input to TMR0.
GP3/MCLR/Vpp	GP3	TTL	—	Input pin. Can be software programmed for internal weak pull-up and wake-up from Sleep on pin change.
	MCLR	ST	_	Master Clear (Reset). When configured as MCLR, this pin is an active-low Reset to the device. Voltage on MCLR/VPP must not exceed VDD during normal device operation or the device will enter Programming mode. Weak pull-up always on if configured as MCLR.
	Vpp	ΗV	—	Programming voltage input.
GP4/OSC2	GP4	TTL	CMOS	Bidirectional I/O pin.
	OSC2	_	XTAL	Oscillator crystal output. Connections to crystal or resonator in Crystal Oscillator mode (XT and LP modes only, GPIO in other modes).
GP5/OSC1/CLKIN	GP5	TTL	CMOS	Bidirectional I/O pin.
	OSC1	XTAL	_	Oscillator crystal input.
	CLKIN	ST	—	External clock source input.
Vdd	Vdd	—	Р	Positive supply for logic and I/O pins.
Vss	Vss		Р	Ground reference for logic and I/O pins.

TABLE 3-2:	PIC12F508/509 PINOUT DESCRIP	NOIT

Legend: I = Input, O = Output, I/O = Input/Output, P = Power, — = Not used, TTL = TTL input, ST = Schmitt Trigger input, HV = High Voltage

4.5 **OPTION Register**

The OPTION register is a 8-bit wide, write-only register, which contains various control bits to configure the Timer0/WDT prescaler and Timer0.

By executing the OPTION instruction, the contents of the W register will be transferred to the OPTION register. A Reset sets the OPTION<7:0> bits.

- Note: If TRIS bit is set to '0', the wake-up on change and pull-up functions are disabled for that pin (i.e., note that TRIS overrides Option control of GPPU/RBPU and GPWU/RBWU).
- If the TOCS bit is set to '1', it will override Note: the TRIS function on the T0CKI pin.

REGISTER 4-3: OPTION REGISTER (PIC12F508/509)

			-	-			
W-1	W-1	W-1	W-1	W-1	W-1	W-1	W-1
GPWU	GPPU	TOCS	T0SE	PSA	PS2	PS1	PS0
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimpler	mented bit, rea	d as '0'	
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unk	nown
bit 7	GPWU: Enab 1 = Disabled 0 = Enabled	le Wake-up on	Pin Change	bit (GP0, GP1,	GP3)		
bit 6	GPPU : Enable Weak Pull-ups bit (GP0, GP1, GP3) 1 = Disabled 0 = Enabled						
bit 5	TOCS : Timer0 Clock Source Select bit 1 = Transition on T0CKI pin (overrides TRIS on the T0CKI pin) 0 = Transition on internal instruction cycle clock, Fosc/4						
bit 4	TOSE : Timer0 1 = Increment 0 = Increment) Source Edge t on high-to-low t on low-to-high	Select bit transition or transition or	n the T0CKI pin n the T0CKI pin			
bit 3	PSA: Prescale 1 = Prescaler 0 = Prescaler	er Assignment assigned to th assigned to Ti	bit e WDT mer0				

bit 2-0 PS<2:0>: Prescaler Rate Select bits

Bit Value	Timer0 Rate	WDT Rate
000	1:2	1:1
001	1:4	1:2
010	1:8	1:4

010	1:8	1:4
011	1:16	1:8
100	1:32	1:16
101	1:64	1:32
110	1 : 128	1:64
111	1:256	1:128

W-1	W-1	W-1	W-1	W-1	W-1	W-1	W-1
RBWU	RBPU	TOCS	TOSE	PSA	PS2	PS1	PS0
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimpler	mented bit, rea	id as '0'	
-n = Value at P	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unki	nown
bit 7	RBWU: Enab 1 = Disabled 0 = Enabled	le Wake-up on	Pin Change I	oit (RB0, RB1,	RB3, RB4)		
bit 6	RBPU : Enable 1 = Disabled 0 = Enabled	e Weak Pull-up	os bit (RB0, R	B1, RB3, RB4)			
bit 5	TOCS : Timer0 clock Source Select bit 1 = Transition on TOCKI pin (overrides TRIS on the TOCKI pin) 0 = Transition on internal instruction cycle clock, Fosc/4						
bit 4	T0SE : Timer0 Source Edge Select bit 1 = Increment on high-to-low transition on the T0CKI pin 0 = Increment on low-to-high transition on the T0CKI pin						
bit 3	 PSA: Prescaler Assignment bit 1 = Prescaler assigned to the WDT 0 = Prescaler assigned to Timer0 						
bit 2-0	PS<2:0>: Pre Bit	scaler Rate Se Value Timer0	elect bits Rate WDT R	ate			
		00 1:2 01 1:4 10 1:8 11 1:1 00 1:3 01 1:6 10 1:1	1:1 1:2 1:4 1:32 1:32 2 1:32 28 1:64 56	2 2 2 2 8			

REGISTER 4-4: OPTION REGISTER (PIC16F505)

5.0 I/O PORT

As with any other register, the I/O register(s) can be written and read under program control. However, read instructions (e.g., MOVF PORTB, W) always read the I/O pins independent of the pin's Input/Output modes. On Reset, all I/O ports are defined as input (inputs are at high-impedance) since the I/O control registers are all set.

Note:	On the PIC12F508/509, I/O PORTB is ref-
	erenced as GPIO. On the PIC16F505, I/O
	PORTB is referenced as PORTB.

5.1 PORTB/GPIO

PORTB/GPIO is an 8-bit I/O register. Only the loworder 6 bits are used (RB/GP<5:0>). Bits 7 and 6 are unimplemented and read as '0's. Please note that RB3/ GP3 is an input only pin. The Configuration Word can set several I/O's to alternate functions. When acting as alternate functions, the pins will read as '0' during a port read. Pins RB0/GP0, RB1/GP1, RB3/GP3 and RB4 can be configured with weak pull-ups and also for wake-up on change. The wake-up on change and weak pull-up functions are not pin selectable. If RB3/GP3/ MCLR is configured as MCLR, weak pull-up is always on and wake-up on change for this pin is not enabled.

5.2 PORTC (PIC16F505 Only)

PORTC is an 8-bit I/O register. Only the low-order 6 bits are used (RC<5:0>). Bits 7 and 6 are unimplemented and read as '0's.

Note:	On	power-up,	TOCKI	functionality	is
	ena	bled in the C	PTION r	egister and mi	ust
	be o	disabled to a	allow RC	5 to be used	as
	gen	eral purpose	I/O.		

5.3 TRIS Registers

The Output Driver Control register is loaded with the contents of the W register by executing the TRIS f instruction. A '1' from a TRIS register bit puts the corresponding output driver in a High-Impedance mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer. The exceptions are RB3/GP3, which is input only and the TOCKI pin, which may be controlled by the OPTION register. See Register 4-3 and Register 4-4.

Note:	A read of the ports reads the pins, not the
	output data latches. That is, if an output
	driver on a pin is enabled and driven high,
	but the external system is holding it low, a
	read of the port will indicate that the pin is
	low.

The TRIS registers are "write-only" and are set (output drivers disabled) upon Reset.

5.4 I/O Interfacing

The equivalent circuit for an I/O port pin is shown in Figure 5-2. All port pins, except RB3/GP3 which is input only, may be used for both input and output operations. For input operations, these ports are non-latching. Any input must be present until read by an input instruction (e.g., MOVF PORTB, W). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit in TRIS must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin (except RB3/GP3) can be programmed individually as input or output.

FIGURE 5-1:

PIC12F508/509/16F505 EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN



7.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits that deal with the needs of real-time applications. The PIC12F508/509/16F505 microcontrollers have a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power-saving operating modes and offer code protection. These features are:

- Oscillator Selection
- Reset:
 - Power-on Reset (POR)
 - Device Reset Timer (DRT)
 - Wake-up from Sleep on Pin Change
- Watchdog Timer (WDT)
- Sleep
- Code Protection
- ID Locations
- In-Circuit Serial Programming[™]
- Clock Out

The PIC12F508/509/16F505 devices have a Watchdog Timer, which can be shut off only through Configuration bit WDTE. It runs off of its own RC oscillator for added reliability. If using HS (PIC16F505), XT or LP selectable oscillator options, there is always an 18 ms (nominal) delay provided by the Device Reset Timer (DRT), intended to keep the chip in Reset until the crystal oscillator is stable. If using INTRC or EXTRC, there is an 18 ms delay only on VDD power-up. With this timer on-chip, most applications need no external Reset circuitry.

The Sleep mode is designed to offer a very low-current Power-Down mode. The user can wake-up from Sleep through a change on input pins or through a Watchdog Timer time-out. Several oscillator options are also made available to allow the part to fit the application, including an internal 4 MHz oscillator. The EXTRC oscillator option saves system cost while the LP crystal option saves power. A set of Configuration bits are used to select various options.

7.1 Configuration Bits

The PIC12F508/509/16F505 Configuration Words consist of 12 bits. Configuration bits can be programmed to select various device configurations. Three bits are for the selection of the oscillator type; (two bits on the PIC12F508/509), one bit is the Watchdog Timer enable bit, one bit is the MCLR enable bit and one bit is for code protection (Register 7-1, Register 7-2).



TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD): SLOW VDD RISE **FIGURE 7-10:**

7.9 Power-down Mode (Sleep)

A device may be powered down (Sleep) and later powered up (wake-up from Sleep).

7.9.1 SLEEP

The Power-Down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the TO bit (STATUS<4>) is set, the PD bit (STATUS<3>) is cleared and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, driving low or high-impedance).

Note: A Reset generated by a WDT time-out does not drive the MCLR pin low.

For lowest current consumption while powered down, the T0CKI input should be at VDD or Vss and the (GP3/RB3)/MCLR/VPP pin must be at a logic high level if MCLR is enabled.

7.9.2 WAKE-UP FROM SLEEP

The device can wake-up from Sleep through one of the following events:

- An external Reset input on (GP3/RB3)/MCLR/ VPP pin, when configured as MCLR.
- 2. A Watchdog Timer time-out Reset (if WDT was enabled).
- A change on input pin GP0/RB0, GP1/RB1, GP3/RB3 or RB4 when wake-up on change is enabled.

These events cause a device Reset. The \overline{TO} , \overline{PD} and GPWUF/RBWUF bits can be used to determine the cause of device Reset. The \overline{TO} bit is cleared if a WDT time-out occurred (and caused wake-up). The \overline{PD} bit, which is set on power-up, is cleared when SLEEP is invoked. The GPWUF/RBWUF bit indicates a change in state while in Sleep at pins GP0/RB0, GP1/RB1, GP3/RB3 or RB4 (since the last file or bit operation on GP/RB port).

Note: Caution: Right before entering Sleep, read the input pins. When in Sleep, wakeup occurs when the values at the pins change from the state they were in at the last reading. If a wake-up on change occurs and the pins are not read before reentering Sleep, a wake-up will occur immediately even if no pins change while in Sleep mode.

The WDT is cleared when the device wakes from Sleep, regardless of the wake-up source.

7.10 Program Verification/Code Protection

If the code protection bit has not been programmed, the on-chip program memory can be read out for verification purposes.

The first 64 locations and the last location (OSCCAL) can be read, regardless of the code protection bit setting.

The last memory location can be read regardless of the code protection bit setting on the PIC12F508/509/ 16F505 devices.

7.11 ID Locations

Four memory locations are designated as ID locations where the user can store checksum or other code identification numbers. These locations are not accessible during normal execution, but are readable and writable during Program/Verify.

Use only the lower 4 bits of the ID locations and always program the upper 8 bits as '0's.

7.12 In-Circuit Serial Programming™

The PIC12F508/509/16F505 microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware, or a custom firmware, to be programmed.

The devices are placed into a Program/Verify mode by holding the <u>GP1/RB1</u> and GP0/RB0 pins low while raising the <u>MCLR</u> (VPP) pin from VIL to VIHH (see programming specification). GP1/RB1 becomes the programming clock and GP0/RB0 becomes the programming data. Both GP1/RB1 and GP0/RB0 are Schmitt Trigger inputs in this mode.

After Reset, a 6-bit command is then supplied to the device. Depending on the command, 14 bits of program data are then supplied to or from the device, depending if the command was a Load or a Read. For complete details of serial programming, please refer to the PIC12F508/509/16F505 Programming Specifications.

A typical In-Circuit Serial Programming connection is shown in Figure 7-15.

IORWF	Inclusive OR W with f
Syntax:	[label] IORWF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ d \in \ [0,1] \end{array}$
Operation:	(W).OR. (f) \rightarrow (dest)
Status Affected:	Z
Description:	Inclusive OR the W register with register 'f'. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.

MOVWF	Move W to f					
Syntax:	[label] MOVWF f					
Operands:	$0 \le f \le 31$					
Operation:	$(W) \rightarrow (f)$					
Status Affected:	None					
Description:	Move data from the W register to register 'f'.					

MOVF	Move f				
Syntax:	[<i>label</i>] MOVF f,d				
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ d \in \ [0,1] \end{array}$				
Operation:	$(f) \rightarrow (dest)$				
Status Affected:	Z				
Description:	The contents of register 'f' are moved to destination 'd'. If 'd' is '0', destination is the W register. If 'd' is '1', the destination is file register 'f'. 'd' = 1 is useful as a test of a file register, since status flag Z is affected.				

NOP	No Operation				
Syntax:	[label] NOP				
Operands:	None				
Operation:	No operation				
Status Affected:	None				
Description:	No operation.				

MOVLW	Move Literal to W				
Syntax:	[<i>label</i>] MOVLW k				
Operands:	$0 \le k \le 255$				
Operation:	k ightarrow (W)				
Status Affected:	None				
Description:	The eight-bit literal 'k' is loaded into the W register. The "don't cares" will assembled as '0's.				

OPTION	Load OPTION Register					
Syntax:	[label] OPTION					
Operands:	None					
Operation:	$(W) \to OPTION$					
Status Affected:	None					
Description:	The content of the W register is loaded into the OPTION register.					

RETLW	Return with Literal in W				
Syntax:	[<i>label</i>] RETLW k				
Operands:	$0 \le k \le 255$				
Operation:	$k \rightarrow (W);$ TOS \rightarrow PC				
Status Affected:	None				
Description:	The W register is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.				

SLEEP	Enter SLEEP Mode
Syntax:	[label] SLEEP
Operands:	None
Operation:	$\begin{array}{l} 00h \rightarrow WDT; \\ 0 \rightarrow WDT \mbox{ prescaler}; \\ 1 \rightarrow \overline{TO}; \\ 0 \rightarrow \overline{PD} \end{array}$
Status Affected:	TO, PD, RBWUF
Description:	Time-out Status bit (TO) is set. The Power-down Status bit (PD) is cleared. RBWUF is unaffected. The WDT and its prescaler are cleared. The processor is put into Sleep mode with the oscillator stopped. See Section 7.9 "Power-down
	Mode (Sleep)" on Sleep for more details.

RLF	Rotate Left f through Carry					
Syntax:	[label]	RLF	f,d			
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ d \in \ [0,1] \end{array}$					
Operation:	See descrip	tion below				
Status Affected:	С					
Description:	The content rotated one the Carry fla is placed in '1', the resu register 'f'.	ts of registe bit to the le ag. If 'd' is 'c the W regis It is stored register	r 'f' are ft through i', the result ster. If 'd' is back in			

SUBWF	Subtract W from f					
Syntax:	[<i>label</i>] SUBWF f,d					
Operands:	$0 \le f \le 31$ $d \in [0,1]$					
Operation:	$(f) - (W) \rightarrow (dest)$					
Status Affected:	C, DC, Z					
Description:	Subtract (2's complement method) the W register from register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.					

RRF	Rotate Right f through Carry					
Syntax:	[label] RRF f,d					
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ d \in \left[0,1 \right] \end{array}$					
Operation:	See description below					
Status Affected:	С					
Description:	The contents of register 'f' are rotated one bit to the right through the Carry flag. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.					
	C register 'f'					

SWAPF	Swap Nibbles in f				
Syntax:	[label] SWAPF f,d				
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ d \in \ [0,1] \end{array}$				
Operation:	$(f<3:0>) \rightarrow (dest<7:4>);$ $(f<7:4>) \rightarrow (dest<3:0>)$				
Status Affected:	None				
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is '0', the result is placed in W register. If 'd' is '1', the result is placed in register 'f'.				

FIGURE 10-7: TIMER0 CLOCK TIMINGS - PIC12F508/509/16F505



TABLE 10-7: TIMER0 CLOCK REQUIREMENTS - PIC12F508/509/16F505

AC CHA	AC CHARACTERISTICS Standard Operating Conditions (unless otherwise specified) Operating Temperature -40°C ≤ TA ≤ +85°C (industrial) -40°C ≤ TA ≤ +125°C (extended) Operating Voltage VDD range is described in Section 10.1 "Power-on Reset (POR)"				ecified)			
Param No.	Sym.	Characte	cteristic Min. Typ ⁽¹⁾ Max. Units			Units	Conditions	
40	Tt0H	T0CKI High Pulse	No Prescaler	0.5 TCY + 20*	_	—	ns	
Width	With Prescaler	10*	—	—	ns			
41	Tt0L	T0CKI Low Pulse	No Prescaler	0.5 TCY + 20*	—	—	ns	
Width	With Prescaler	10*	—	—	ns			
42	Tt0P	T0CKI Period		20 or Tcy + 40* N		_	ns	Whichever is greater. N = Prescale Value (1, 2, 4,, 256)

These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.









the case of other types of Reset events.









NOTES:

8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS		
Dimens	sion Limits	MIN	NOM	MAX	
Number of Pins	Ν	8			
Pitch	е	0.65 BSC			
Overall Height	А	_	-	1.10	
Molded Package Thickness	A2	0.75	0.85	0.95	
Standoff	A1	0.00	-	0.15	
Overall Width	E	4.90 BSC			
Molded Package Width	E1	3.00 BSC			
Overall Length	D	3.00 BSC			
Foot Length	L	0.40	0.60	0.80	
Footprint	L1	0.95 REF			
Foot Angle	ф	0°	-	8°	
Lead Thickness	С	0.08	-	0.23	
Lead Width	b	0.22	—	0.40	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.

3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-111B

14-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	INCHES		
Di	mension Limits	MIN	NOM	MAX
Number of Pins	N	14		
Pitch	e	.100 BSC		
Top to Seating Plane	А	-	-	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	-	-
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.735	.750	.775
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	С	.008	.010	.015
Upper Lead Width	b1	.045	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	-	-	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located with the hatched area.

2. § Significant Characteristic.

3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.

4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-005B

16-Lead Plastic Quad Flat, No Lead Package (MG) - 3x3x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	N	MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	
Number of Pins	N	16			
Pitch	е	0.50 BSC			
Overall Height	A	0.80	0.85	0.90	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	E	3.00 BSC			
Exposed Pad Width	E2	1.00	1.10	1.50	
Overall Length	D	3.00 BSC			
Exposed Pad Length	D2	1.00	1.10	1.50	
Contact Width	b	0.18	0.25	0.30	
Contact Length	L	0.25	0.35	0.45	
Contact-to-Exposed Pad	K	0.20	-	_	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

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